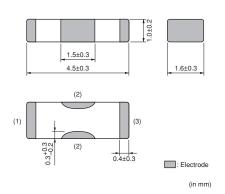
Data Sheet

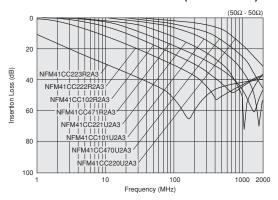
EMIFIL® (Capacitor type) Single Circuit Type for Signal Lines

NFM41C Series (1806 Size)

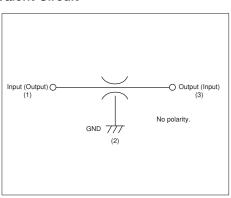
Dimensions



■ Insertion Loss Characteristics (Main Items)



■ Equivalent Circuit



Packaging

Code	Packaging	Minimum Quantity	
L	180mm Embossed Tape	4000	
В	Bulk(Bag)	500	

■ Rated Value (□: packaging code)

Part Number	Capacitance	Rated Current	Rated Voltage	Insulation Resistance (min.)	Operating Temperature Range
NFM41CC220U2A3	22pF 50/-20%	300mA	100Vdc	10000M ohm	-55 to +125°C
NFM41CC470U2A3	47pF 50/-20%	300mA	100Vdc	10000M ohm	-55 to +125°C
NFM41CC101U2A3	100pF 50/-20%	300mA	100Vdc	10000M ohm	-55 to +125°C
NFM41CC221U2A3□	220pF 50/-20%	300mA	100Vdc	10000M ohm	-55 to +125°C
NFM41CC471R2A3□	470pF 50/-20%	300mA	100Vdc	10000M ohm	-55 to +125°C
NFM41CC102R2A3□	1000pF 50/-20%	300mA	100Vdc	10000M ohm	-55 to +125°C
NFM41CC222R2A3□	2200pF 50/-20%	300mA	100Vdc	10000M ohm	-55 to +125°C
NFM41CC223R2A3□	22000pF 50/-20%	300mA	100Vdc	10000M ohm	-55 to +125°C

Number of Circuit: 1

Continued on the following page. \nearrow



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- 2. This datasheet has only typical specifications because there is no space for detailed specifications. Therefore, please approve our product specifications or transact the approval sheet for product specifications before ordering.

Data Sheet

Continued from the preceding page.

■ ①Caution/Notice

Do not use products beyond the rated current and rated voltage as this may create excessive heat and deteriorate the insulation resistance.

Notice

Solderability of Tin plating termination chip might be deteriorated when low temperature soldering profile where peak solder temperature is below the Tin melting point is used. Please confirm the solderability of Tin plating termination chip before use.

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